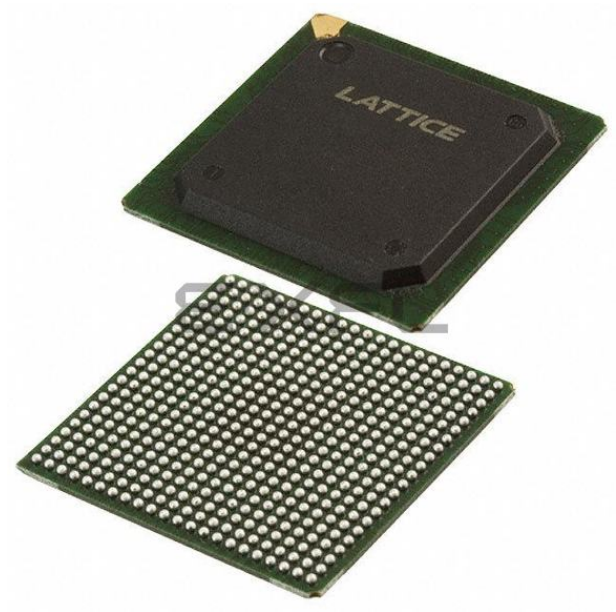
Lattice Semiconductor Corporation - LC5768MV-75FN484I Datasheet



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Understanding Embedded - CPLDs (Complex Programmable Logic Devices)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details	
Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	7.5 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	24
Number of Macrocells	768
Number of Gates	-
Number of I/O	317
Operating Temperature	-40°C ~ 105°C (TJ)
Mounting Type	Surface Mount
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lc5768mv-75fn484i

Product Line	Ordering Part Number	Product Status	Reference PCN
LC5512MV	LC5512MV-45Q208C	Active / Orderable	
	LC5512MV-45QN208C		
	LC5512MV-75Q208C		
	LC5512MV-75QN208C		
	LC5512MV-75Q208I		
	LC5512MV-75QN208I		
	LC5512MV-45F256C		
	LC5512MV-45FN256C		
	LC5512MV-75F256C		
	LC5512MV-75FN256C		
	LC5512MV-75F256I		
	LC5512MV-75FN256I		
	LC5512MV-45F484C		
	LC5512MV-45FN484C		
	LC5512MV-75F484C		
	LC5512MV-75FN484C		
	LC5512MV-75F484I		
	LC5512MV-75FN484I		
LC5512MB	LC5512MB-45Q208C	**Discontinued**	PCN#09-10
	LC5512MB-45QN208C		
	LC5512MB-75Q208C		
	LC5512MB-75QN208C		
	LC5512MB-75Q208I		
	LC5512MB-75QN208I		
	LC5512MB-45F256C	Active / Orderable	
	LC5512MB-45FN256C		
	LC5512MB-75F256C		
	LC5512MB-75FN256C		
	LC5512MB-75F256I		
	LC5512MB-75FN256I		
	LC5512MB-45F484C	**Discontinued**	PCN#09-10
	LC5512MB-45FN484C		
	LC5512MB-75F484C		
	LC5512MB-75FN484C		
	LC5512MB-75F484I		
	LC5512MB-75FN484I		
LC5512MC	LC5512MC-45Q208C	**Discontinued**	PCN#09-10
	LC5512MC-45QN208C		
	LC5512MC-75Q208C		
	LC5512MC-75QN208C		
	LC5512MC-75Q208I		
	LC5512MC-75QN208I		
	LC5512MC-45F256C		
	LC5512MC-45FN256C		
	LC5512MC-75F256C		
	LC5512MC-75FN256C		
	LC5512MC-75F256I		
	LC5512MC-75FN256I		

Product Line	Ordering Part Number	Product Status	Reference PCN
LC5512MC (Cont'd)	LC5512MC-45F484C	**Discontinued**	PCN#09-10
	LC5512MC-45FN484C		
	LC5512MC-75F484C		
	LC5512MC-75FN484C		
	LC5512MC-75F484I		
	LC5512MC-75FN484I		
LC5768MV	LC5768MV-5F256C	Active / Orderable	
	LC5768MV-5FN256C		
	LC5768MV-75F256C		
	LC5768MV-75FN256C		
	LC5768MV-75F256I		
	LC5768MV-75FN256I		
	LC5768MV-5F484C		
	LC5768MV-5FN484C		
	LC5768MV-75F484C		
	LC5768MV-75FN484C		
	LC5768MV-75F484I		
	LC5768MV-75FN484I		
LC5768MB	LC5768MB-5F256C	**Discontinued**	PCN#09-10
	LC5768MB-5FN256C		
	LC5768MB-75F256C		
	LC5768MB-75FN256C		
	LC5768MB-75F256I		
	LC5768MB-75FN256I		
	LC5768MB-5F484C		
	LC5768MB-5FN484C		
	LC5768MB-75F484C		
	LC5768MB-75FN484C		
	LC5768MB-75F484I		
	LC5768MB-75FN484I		
LC5768MC	LC5768MC-5F256C	**Discontinued**	PCN#09-10
	LC5768MC-5FN256C		
	LC5768MC-75F256C		
	LC5768MC-75FN256C		
	LC5768MC-75F256I		
	LC5768MC-75FN256I		
	LC5768MC-5F484C		
	LC5768MC-5FN484C		
	LC5768MC-75F484C		
	LC5768MC-75FN484C		
	LC5768MC-75F484I		
	LC5768MC-75FN484I		

ispXPLD™ 5000MX Family

3.3V, 2.5V and 1.8V In-System Programmable
eXpanded Programmable Logic Device XPLD™ Family

February 2010 **Data Sheet**

Features

- **Flexible Multi-Function Block (MFB) Architecture**
  - SuperWIDE™ logic (up to 136 inputs)
  - Arithmetic capability
  - Single- or Dual-port SRAM
  - FIFO
  - Ternary CAM
- **sysCLOCK™ PLL Timing Control**
  - Multiply and divide between 1 and 32
  - Clock shifting capability
  - External feedback capability
- **sysIO™ Interfaces**
  - LVCMOS 1.8, 2.5, 3.3V
    - Programmable impedance
    - Hot-socketing
    - Flexible bus-maintenance (Pull-up, pull-down, bus-keeper, or none)
    - Open drain operation
  - SSTL 2, 3 (I & II)
  - HSTL (I, III, IV)
  - PCI 3.3
  - GTL+
  - LVDS
  - LVPECL
  - LVTTL
- **Expanded In-System Programmability (ispXP™)**
  - Instant-on capability
  - Single chip convenience
  - In-System Programmable via IEEE 1532 Interface
  - Infinitely reconfigurable via IEEE 1532 or sysCONFIG™ microprocessor interface
  - Design security
- **High Speed Operation**
  - 4.0ns pin-to-pin delays, 300MHz f_{MAX}
  - Deterministic timing
- **Low Power Consumption**
  - Typical static power: 20 to 50mA (1.8V), 30 to 60mA (2.5/3.3V)
  - 1.8V core for low dynamic power
- **Easy System Integration**
  - 3.3V (5000MV), 2.5V (5000MB) and 1.8V (5000MC) power supply operation
  - 5V tolerant I/O for LVCMOS 3.3 and LVTTL interfaces
  - IEEE 1149.1 interface for boundary scan testing
  - sysIO quick configuration
  - Density migration
  - Multiple density and package options
  - PQFP and fine pitch BGA packaging
  - Lead-free package options

Table 1. ispXPLD 5000MX Family Selection Guide

	ispXPLD 5256MX	ispXPLD 5512MX	ispXPLD 5768MX	ispXPLD 51024MX
Macrocells	256	512	768	1,024
Multi-Function Blocks	8	16	24	32
Maximum RAM Bits	128K	256K	384K	512K
Maximum CAM Bits	48K	96K	144K	192K
sysCLOCK PLLs	2	2	2	2
t_{PD} (Propagation Delay)	4.0ns	4.5ns	5.0ns	5.2ns
t_S (Register Set-up Time)	2.2ns	2.8ns	2.8ns	3.0ns
t_{CO} (Register Clock to Out Time)	2.8ns	3.0ns	3.2ns	3.7ns
f_{MAX} (Maximum Operating Frequency)	300MHz	275MHz	250MHz	250MHz
Functional Gates	75K	150K	225K	300K
I/Os	141	149/193/253	193/317	317/381
Packages	256 fpBGA	208 PQFP 256 fpBGA 484 fpBGA	256 fpBGA 484 fpBGA	484 fpBGA 672 fpBGA

5000MX. Incoming signals may connect to the global routing pool or the registers in the MFBs. An Output Sharing Array (OSA) increases the number of I/O available to each MFB, allowing a complete function high-performance access to the I/O. There are four clock pins that drive four global clock nets within the device. Two sysCLOCK PLLs are provided to allow the synthesis of new clocks and control of clock skews.

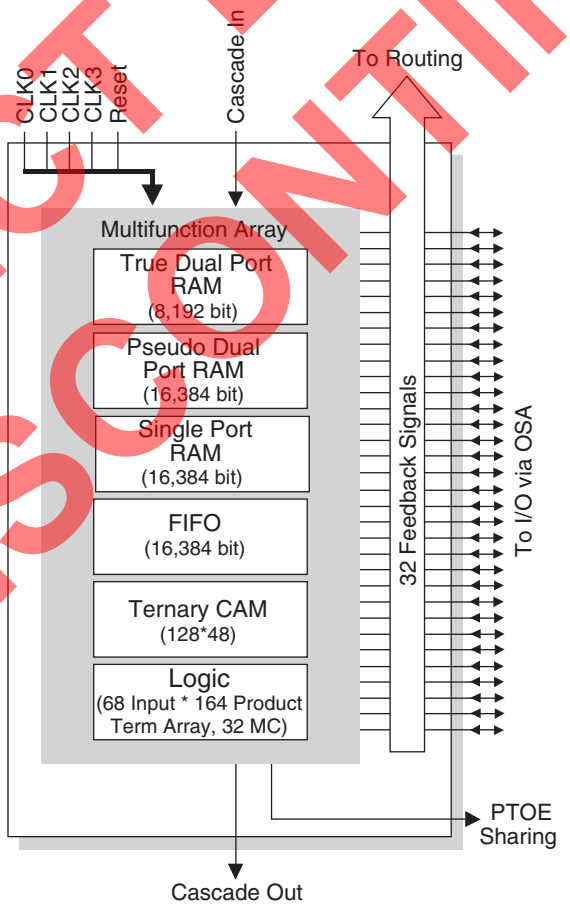
Multi-Function Block (MFB)

Each MFB in the ispXPLD 5000MX architecture can be configured in one of the six following modes. This provides a flexible approach to implementing logic and memory that allows the designer to achieve the mix of functions that are required for a particular design, maximizing resource utilization. The six modes supported by the MFB are:

- SuperWIDE Logic Mode
- True Dual-port SRAM Mode
- Pseudo Dual-port SRAM Mode
- Single-port SRAM Mode
- FIFO Mode
- Ternary CAM Mode

The MFB consists of a multi-function array and associated routing. Depending on the chosen functions the multi-function array uses up to 68 inputs from the GRP and the four global clock and reset signals. The array outputs data along with certain control functions to the macrocells. Output signals can be routed internally for use elsewhere in the device and to the sysIO banks for output. Figure 2 shows the block diagram of the MFB. The various configurations are described in more detail in the following sections.

Figure 2. MFB Block Diagram



Cascading For Wide Operation

In several modes it is possible to cascade adjacent MFBs to support wider operation. Table 2 details the different cascading options. There are chains of MFBs in each device which determine those MFBs that are adjacent for the purposes of cascading. Table 3 indicates these chains. The ispXPLD 5000MX design tools automatically cascade blocks if required by a particular design.

Table 2. Cascading Modes For Wide Support

Mode	Cascading Function
Logic	**Input Width.** Allows two MFBs to act as a 136-input block.
	Arithmetic. Allow the carry chain to pass between two MFBs.
FIFO	**Memory Width Expansion.** Allows MFBs to be cascaded for greater width support.
CAM	**Memory Width Expansion.** Allows up to four MFBs to be cascaded for greater width support.

Table 3. MFB Cascade Chain

Device	MFBs in Cascade Chain
ispXPLD 5256MX	A → B → C → D
	H -> G -> F -> E
ispXPLD 5512MX	A → B → C → D → E → F → G → H
	P → O → N → M → L → K → J → I
ispXPLD 5768MX	D → C → B → A → X → W → V → U → T → S → R → Q
	E → F → G → H → I → J → K → L → M → N → O → P
ispXPLD 51024MX	H → G → F → E → D → C → B → A → AF → AE → AD → AC → AB → AA → Z → Y
	I → J → K → L → M → N → O → P → Q → R → S → T → U → V → W → X

SuperWIDE Logic Mode

In logic mode, each MFB contains 32 macrocells and a fully populated, programmable AND-array with 160 logic product terms and four control product terms. The MFB has 68 inputs from the Global Routing Pool, which are available in both true and complement form for every product term. It is also possible to cascade adjacent MFBs to create a block with 136 inputs. The four control product terms are used for shared reset, clock, clock enable, and output enable functions. Figure 3 shows the overall structure of the MFB in logic mode while Figure 4 provides a more detailed view from the perspective of a macrocell slice.

Output Sharing Array (OSA)

A number of I/O pads are available in each sysIO bank to route the selected number of macrocells from the MFB outputs directly to the I/O pads in logic mode. In the ispXPLD 5000MX, the large number of inputs and PTs to the MFB as well as the presence of the PTSA can cover most routing flexibility of signals to I/O cells. The Output Sharing Array gives additional routing capability and I/O access to an MFB when a wide output function takes up the whole MFB and cannot be easily divided across multiple MFBs. By using the OSA, the wide output function, such as 32-bit FIFO, can have all of its output signals from the one MFB routed to I/O cells. In a given I/O block, the wide output functions must share the I/O pads with other logic functions.

The OSA bypass option routes the MFB signal directly to the I/O cell, allowing a direct connection to the I/O cell. The logic functions use the option to provide faster speed to the outputs. The Logic Signal Connection tables list the OSA bypass as the primary macrocell and OSA options as alternate macrocells. Similarly, the Alternate Input listing in the table shows the alternate macrocell input connection for a given I/O pin. Figure 17 shows the alternate macrocell connections in an I/O cell.

sysIO Banks

The ispXPLD 5000MX devices are divided into four sysIO banks, consisting of multiple I/O cells, where each bank is capable of supporting 16 different I/O standards. Each sysIO bank has its own I/O voltage (V_{CCO}) and reference voltage (V_{REF}) resources allowing complete independence from the others.

I/O Cell

The I/O cell of the ispXPLD 5000MX devices contains an output enable (OE) MUX, a programmable tri-state output buffer, a programmable input buffer, and programmable bus-maintenance circuitry.

The I/O cell receives inputs from its associated macrocells and the device pin. The I/O cell has a feedback line to its associated macrocells and a direct path to GRP. The output enable (OE) MUX selects the OE signal per I/O cell. The inputs to the OE MUX are the four global PTOE signals, PTOE and the two GOE signals. The OE MUX also has the ability to choose either the true or inverse of each of these signals. The output of the OE MUX goes through a logical AND with the TOE signal to allow easy tri-stating of the outputs for testing purposes. The MFBs are grouped into segments of four for the purpose of generating Shared PTOE signals. Each Shared PTOE signal is derived from PT 163 from one of the four MFBs. Table 10 shows the segments. The PTOE signal is derived from the first product term in each macrocell cluster, which is directly routed to the OE MUX. Therefore, every I/O cell can have a different OE signal. Figure 17 is a graphical representation of the I/O cell.

Table 12. ispXPLD 5000MX Supported I/O Standards

sysIO Standard	Nominal V_{CCO}	Nominal V_{REF}	Nominal V_{TT}
LVTTL	3.3V	N/A	N/A
LVCMOS-3.3	3.3V	N/A	N/A
LVCMOS-2.5	2.5V	N/A	N/A
LVCMOS-1.8	1.8V	N/A	N/A
PCI 3.3V	3.3V	N/A	N/A
AGP-1X	3.3V	N/A	N/A
SSTL3, Class I & II	3.3V	1.5V	1.5V
SSTL2, Class I & II	2.5V	1.25V	1.25V
CTT 3.3	3.3V	1.5V	1.5V
CTT 2.5	2.5V	1.25V	1.25V
HSTL, Class I	1.5V	0.75V	0.75V
HSTL, Class III	1.5V	0.9V	0.75V
HSTL, Class IV	1.5V	0.9V	0.75V
GTL+	N/A	1.0V	1.5V
LVPECL, Differential	2.5V, 3.3V	N/A	N/A
LVDS	2.5V, 3.3V	N/A	N/A

Table 13. Differential Interface Standard Support[1]

		sysIO Buffer
LVDS	Driver	Supported
	Receiver	Supported with standard termination
LVPECL	Driver	Supported with external resistor network
	Receiver	Supported with termination

1. For more information, refer to TN1000 – sysIO Usage Guidelines for Lattice Devices.

Control, Clock, sysCONFIG and JTAG Signals

Global clock pins support the same sysIO standards as general purpose I/O. When required the V_{REF} signal is derived from the adjacent bank. When differential standards are supported two adjacent clock pins are paired to form the input. The TOE, PROGRAM, CFG0 and DONE pins of the ispXPLD 5000MX device are the only pins that do not have sysIO capabilities. The JTAG TAP pins support only LVCMOS 3.3, 2.5 and 1.8V standards. The voltage is controlled by V_{CCJ}. These pins only support the LVTTL and LVCMOS standards applicable to the power supply voltage of the device. The global reset global output enable pins are associated with Bank 2 and support all of the sysIO standards.

Hotsocketing

The I/O on the ispXPLD 5000MX devices are well suited for those applications that require hot socketing capability, when configured as LVCMOS or LVTTL. Hot socketing a device requires that the device, when powered down, can tolerate active signals on the I/Os and inputs without being damaged. Additionally, it requires that the effects of the powered-down device be minimal on active signals.

Programmable Drive Strength

The drive strength of I/Os that are programmed as LVCMOS is tightly controlled and can be programmed to a variety of different values. Thus the impedance an output driver can be closely match to the characteristic impedance of the line it is driving. This allows users to eliminate the need for external series termination resistors.

sysIO Recommended Operating Conditions

Standard	V_{CCO} (V)[2]			V_{REF} (V)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
LVCMOS 3.3	3.0	3.3	3.6	—	—	—
LVCMOS 2.5	2.3	2.5	2.7	—	—	—
LVCMOS 1.8[1]	1.65	1.8	1.95	—	—	—
LVTTL	3.0	3.3	3.6	—	—	—
PCI 3.3	3.0	3.3	3.6	—	—	—
AGP-1X	3.15	3.3	3.45	—	—	—
SSTL 2	2.3	2.5	2.7	1.15	1.25	1.35
SSTL 3	3.0	3.3	3.6	1.3	1.5	1.7
CTT 3.3	3.0	3.3	3.6	1.35	1.5	1.65
CTT 2.5	2.3	2.5	2.7	1.35	1.5	1.65
HSTL Class I	1.4	1.5	1.6	0.68	0.75	0.9
HSTL Class III	1.4	1.5	1.6	—	0.9	—
HSTL Class IV	1.4	1.5	1.6	—	0.9	—
GTL+	1.4	—	3.6	0.882	1.0	1.122
LVDS	2.3	2.5/3.3	3.6	—	—	—

1. Design tools default setting.
2. Inputs are independent of V_{CCO} setting. However, V_{CCO} must be set within the valid operating range for one of the supported standards.

ispXPLD 5000MX Family Internal Switching Characteristics (Continued)

Over Recommended Operating Conditions

Parameter	Description	Base Parameter	-4		-45		-5		-52		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
$t_{CAMWMSKS}$	Write Mask Register Setup Time before Clock	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
$t_{CAMWMSKH}$	Write Mask Register Setup Time after Clock	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
$t_{CAMRSTO}$	Reset to CAM Output Delay	—	—	3.30	—	3.30	—	4.13	—	4.13	—	4.29	ns
$t_{CAMRSTR}$	Reset Recovery Time	—	1.20	—	1.20	—	1.50	—	1.50	—	1.56	—	ns
$t_{CAMRSTPW}$	Reset Pulse Width	—	0.14	—	0.14	—	0.18	—	0.18	—	0.19	—	ns
CAM – Compare Mode													
$t_{CAMDATAS}$	Data Setup Time before Clock	—	-0.41	—	-0.41	—	-0.33	—	-0.33	—	-0.31	—	ns
$t_{CAMDATAH}$	Data Hold Time after Clock	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
$t_{CAMENMSKS}$	Enable Mask Register Setup Time before Clock	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
$t_{CAMENMSKH}$	Enable Mask Register Setup Time after Clock	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
$t_{CAMCASC}$	CAM Width Expansion Delay	—	—	0.40	—	0.40	—	0.50	—	0.50	—	0.51	ns
t_{CAMCO}	Clock to Output (Address Out) Delay	—	—	6.19	—	6.13	—	6.81	—	6.61	—	9.63	ns
$t_{CAMMATCH}$	Clock to Match Flag Delay	—	—	6.19	—	6.13	—	6.07	—	6.61	—	10.22	ns
$t_{CAMMMATCH}$	Clock to Multi-Match Flag Delay	—	—	5.50	—	5.50	—	6.38	—	6.38	—	7.72	ns
$t_{CAMRSTFLAG}$	CAM Reset to Flags Delay	—	—	3.16	—	3.16	—	3.95	—	3.95	—	4.11	ns
Single Port RAM													
$t_{SPADDDATA}$	Address to Data Delay	—	—	5.97	—	5.97	—	5.97	—	5.97	—	7.76	ns
t_{SPMSS}	Memory Select Setup Before Clock Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
t_{SPMSH}	Memory Select Hold time after Clock Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t_{SPCES}	Clock Enable Setup before Clock Time	—	2.30	—	2.30	—	2.30	—	2.30	—	9.80	—	ns
t_{SPCEH}	Clock Enable Hold time after Clock Time	—	-2.95	—	-2.95	—	-2.95	—	-2.95	—	-2.27	—	ns
t_{SPADDS}	Address Setup before Clock Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns

ispXPLD 5000MX Family Timing Adders (Continued)

Parameter	Description	Base Param.	-4		-45		-5		-52		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
HSTL_I_out	Using HSTL 2.5V, Class I	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
HSTL_III_out	Using HSTL 2.5V, Class III	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
HSTL_IV_out	Using HSTL 2.5V, Class IV	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
LVDS_out	Using Low Voltage Differential Signaling (LVDS)	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.8	—	0.8	—	0.8	—	0.8	—	0.8	ns
LVPECL_out	Using Low Voltage PECL	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns
PCI_out	Using PCI Standard	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
SSTL2_I_out	Using SSTL 2.5V, Class I	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns
SSTL2_II_out	Using SSTL 2.5V, Class II	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
SSTL3_I_out	Using SSTL 3.3V, Class I	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.2	—	0.2	—	0.2	—	0.2	—	0.2	ns
SSTL3_II_out	Using SSTL 3.3V, Class II	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.4	—	0.4	—	0.4	—	0.4	—	0.4	ns

Timing v.1.8

ispXP sysCONFIG Port Timing Specifications

Symbol	Timing Parameter	Min.	Max.	Units
sysCONFIG Write Cycle Timing				
t_{SUCS}	Input setup time of CS to CCLK rise	10	—	ns
t_{HCS}	Hold time of CS to CCLK rise	1	—	ns
t_{SUWD}	Input setup time of write data to CCLK rise	10	—	ns
t_{HWD}	Hold time of write data to CCLK rise	0	—	ns
t_{PRGM}	Low time to reset device SRAM	5	50	ns
t_{DINIT}	INIT delay time	—	5	ms
t_{IODISS}	User I/O disable	—	—	ns
t_{IOENSS}	User I/O enable	—	—	ns
t_{WH}	Write clock High pulse width	18	—	ns
t_{WL}	Write clock Low pulse width	18	—	ns
f_{MAXW}	Write f_{MAX}	—	27	MHz
sysCONFIG Read Cycle Timing				
t_{HREAD}	Hold time of READ to CCLK rise	1	—	ns
t_{SUREAD}	Input setup time of READ High to CCLK rise	15	—	ns
t_{RH}	READ clock high pulse width	18	—	ns
t_{RL}	READ clock low pulse width	18	—	ns
f_{MAXR}	Read f_{MAX}	—	27	MHz
t_{CORD}	Clock to out for read data	—	25	ns

ispXPLD 5512MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	208 PQFP Pin Number	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2				
3	79N	K8	K5	L8	K9	—	—	F13
3	79P	K6	K4	L6	K7	—	—	F15
3	80N	K5	K3	L5	—	—	—	D16
3	80P	K4	K2	L4	—	—	E10[1]	E16
3	81N	K2	K1	L2	K3	—	A12	A16
3	81P	K0	K0	L0	K1	—	A11	A15
—	—	GND (Bank 3)	—	—	—	—	GND (Bank 3)	GND (Bank 3)
3	82N	L30	I15	K15	L31	162	B11	B15
—	—	V_{CCO3}	—	—	—	—	V_{CCO3}	V_{CCO3}
3	82P	L28	I14	K14	L29	163	C11	A14
3	83N	L26	I13	K13	L27	164	B10	D15
3	83P	L24	I12	K12	L25	165	A10	E15
3	84N	L22	I11	K11	L23	166	C10	D14
3	84P	L21	I10	K10	—	167	D10	F14
3	85N	L20	I9	K9	—	168	C9	A13
3	85P	L18	I8	K8	L19	169	E9	B13
3	86N	L16/VREF3	I29	K29	L17	170	D9	C14
3	86P	L14	I28	K28	L15	171	F9	E14
3	87N	L12	I7	K7	L13	172	A9	E13
3	87P	L10	I6	K6	L11	173	F8	F12
—	—	GND (Bank 3)	—	—	—	174	GND (Bank 3)	GND (Bank 3)
3	88N	L8	I5	K5	L9	175	E8	D13
—	—	V_{CCO3}	—	—	—	176	V_{CCO3}	V_{CCO3}
3	88P	L6	I4	K4	L7	177	A8	C13
3	89N	L5	I3	K3	—	178	B9	E12
3	89P	L4	I2	K2	—	179	D8	C12
—	—	VCC	—	—	—	180	VCC	VCC
3	90N	L2	I1	K1	L3	181	B8	B12
3	90P	L0	I0	K0	L1	182	C8	A12
0	91N	M30	M31	O31	M31	183	B7	E11
0	91P	M28	M30	O30	M29	184	A7	C11
—	—	GND	—	—	—	185	—	GND
—	—	GND	—	—	—	—	GND	GND
0	92N	M26	M29	O29	M27	186	D7	B11
0	92P	M24	M28	O28	M25	187	C7	A11
0	93N	M22	M27	O27	M23	188	B6	F11
—	—	V_{CCO0}	—	—	—	189	V_{CCO0}	V_{CCO0}
0	93P	M21	M26	O26	M22	190	E7	F10
—	—	GND (Bank 0)	—	—	—	191	GND (Bank 0)	GND (Bank 0)
0	94N	M20	M25	O25	M21	192	E6	E10
0	94P	M18	M24	O24	M19	193	A6	C10
0	95N	M16/V_{REF0}	M3	O3	M17	194	A5	D10
0	95P	M14	M2	O2	M15	195	A4	B10

ispXPLD 5512MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	208 PQFP Pin Number	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2				
0	96N	M12	M23	O23	M13	196	B5	A10
0	96P	M10	M22	O22	M11	197	A3	A9
0	97N	M8	M21	O21	M9	198	B4	C9
0	97P	M6	M20	O20	M7	199	B3	D9
0	98N	M5	M19	O19	—	200	C5	F9
0	98P	M4	M18	O18	—	201	C6	E9
0	99N	M2	M1	O1	M3	202	D5	A8
—	—	V_{CCO0}	—	—	—	—	V_{CCO0}	V_{CCO0}
0	99P	M0	M0	O0	M1	203	D6	B8
—	—	GND (Bank 0)	—	—	—	—	GND (Bank 0)	GND (Bank 0)
0	100N	N30	O29	—	N31	—	—	A7
0	100P	N28	O28	—	N29	—	—	B7
0	101N	N26	O27	—	N27	—	—	A5
0	101P	N24	O26	—	N25	—	—	B5
0	102N	N22	O25	—	N23	—	—	B6
0	102P	N21	O24	—	—	—	—	C7
0	103N	N20	O23	—	—	—	—	E8
0	103P	N18	O22	—	N19	—	—	E7
0	104N	N16	O21	—	N17	—	—	E6
0	104P	N14	O20	—	N15	—	—	D6
0	105N	N12	O19	—	N13	—	—	D8
—	—	V_{CCO0}	—	—	—	204	V_{CCO0}	V_{CCO0}
0	105P	N10	O18	—	N11	—	—	F8
—	—	GND (Bank 0)	—	—	—	205	GND (Bank 0)	GND (Bank 0)
0	106N	N8	O17	—	N9	—	—	F7
0	106P	N6	O16	—	N7	—	—	D7
0	107N	N5	O15	—	—	206	A2	C6
0	107P	N4	O14	—	—	207	B2	C5
0	108N	N2	O13	—	N3	—	—	C4
0	108P	N0	O12	—	N1	—	—	D5

1. Not available for differential pair.

Global Clock LVDS pair options: GCLK0 and GCLK1, as well as GCLK2 and GCLK3, can be paired together to receive differential clocks; where GCLK0 and GCLK3 are the positive LVDS inputs.

ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
2	46N	G6	H19	-	G7	—	AB19
2	47P	G8	H20	-	G9	—	AA19
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	47N	G10	H21	-	G11	—	U17
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	48P	G12	H22	-	G13	—	V18
2	48N	G14	H23	-	G15	—	AB21
2	49P	G16	H24	-	G17	—	U18
2	49N	G18	H25	-	G19	—	T17
2	50P	G20	H26	-	G21	R16	AB20
2	50N	G22	H27	-	G23	P16	AA20
2	51P	G24	H28	-	G25	N15	Y19
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	51N	G26	H29	-	G27	N14	V19
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	52P	G28	F16	H16	G29	N16	T18
2	52N	G30	F17	H17	G31	M16	R17
2	53P	H0	F18	H18	H1	M14	U19
2	53N	H2	F19	H19	H3	M15	T19
2	54P	H4	H30	E24	H5	—	V20
-	-	VCC	-	-	-	VCC	VCC
2	54N	H6	H31	E26	H7	—	U20
2	55P	H8	F20	H20	H9	L13	W20
2	55N	H10	F21	H21	H11	L12	Y21
2	56P	H12	F22	H22	H13	L15	R18
2	56N	H14	F23	H23	H15	L16	R19
-	-	GND	-	-	-	GND	GND
2	57P	H16	F24	H24	H17	L14	W21
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	57N	H18	F25	H25	H19	K15	Y22
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	58P	H20	F26	H26	H21	K14	R20
2	58N	H22	F27	H27	H23	K12	P20
2	59P	H24	F28	H28	H25	K13	T21
2	59N	H26	F29	H29	H27	J13	R21
2	60P	H28	F30	H30	H29	J14	U21
2	60N	H30	F31	H31	H31	J12	V21
-	-	TOE	-	-	-	J15	W22
-	-	RESET	-	-	-	J11	V22
-	-	GOE0	-	-	-	H11	T22
-	-	GOE1	-	-	-	H13	R22
-	-	GNDP	-	-	-	See Power Supply and NC Connections Table	

ispXPLD 51024MX Logic Signal Connections

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
0	159N	AA22	AA11	AB18	AA23	B4	C2
0	159P	AA20	AA10	AB16	AA21	A4	C1
0	160N	AA18	Y17	AA17	AA19	B3	D4
0	160P	AA16	Y16	AA16	AA17	A3	D3
0	161N	AA14	Y15	AA15	AA15	F5	D2
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	161P	AA12	Y14	AA14	AA13	G6	D1
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	162N	AA10	Y13	AA13	AA11	H6	E5
0	162P	AA8	Y12	AA12	AA9	G5	E4
0	163N	AA6	AA9	AB14	AA7	D3	E3
0	163P	AA4	AA8	AB12	AA5	D2	E2
0	164N	AA2	AA7	AB10	AA3	E4	E1
-	-	VCC	-	-	-	VCC	VCC
0	164P	AA0	AA6	AB8	AA1	E3	F2
-	-	GND	-	-	-	GND	GND
0	165N	AB30	AA5	AB6	AB31	F4	F5
0	165P	AB28	AA4	AB4	AB29	G4	G6
0	166N	AB26	AA3	AB2	AB27	C2	F4
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	166P	AB24	AA2	AB0	AB25	C1	F3
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	167N	AB22	AA1	-	AB23	F3	F1
0	167P	AB20	AA0	-	AB21	G3	G1
0	168N	AB18	AA31	-	AB19	H4	G5
-	-	VCC	-	-		VCC	VCC
0	168P	AB16	AA30	-	AB17	J4	G4
0	169N	AB14	Y11	AA11	AB15	H5	H7
0	169P	AB12/CLK_OUT0	Y10	AA10	AB13	J5	J7
0	170N	AB10	Y9	AA9	AB11	E2	G3
0	170P	AB8	Y8	AA8	AB9	F2	G2
-	-	GND	-	-	-	GND	GND
0	171N	AB6	Y7	AA7	AB7	D1	H6
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	171P	AB4	Y6	AA6	AB5	E1	J6
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	172N	AB2	Y5	AA5	AB3	J3	H5
0	172P	AB0/PLL_RST0	Y4	AA4	AB1	H2	H4
0	173N	AC30	AC31	AE31	AC31	G2	H3
0	173P	AC28/PLL_FBK0	AC30	AE30	AC29	G1	H2
0	174N	AC26	AC29	AE29	AC27	J6	H1
0	174P	AC24	AC28	AE28	AC25	K4	J1

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
1	31P	G26	H16	-	G27	V6	AB7
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	31N	G24	H18	-	G25	V7	AC7
-	-	GND	-	-	-	GND	GND
1	32P	G22	H20	-	G23	Y5	AB6
-	-	VCC	-	-	-	VCC	VCC
1	32N	G20	H22	-	G21	AA5	AC6
1	33P	G18	-	-	G19	Y6	AC8
1	33N	G16	-	-	G17	Y7	AC9
1	34P	G14	-	-	G15	AA6	AC5
1	34N	G12	-	-	G13	AA7	AD4
1	35P	G10	-	-	G11	W7	AD5
1	35N	G8	-	-	G9	V8	AD6
1	36P	G6	-	-	G7	W8	AD7
1	36N	G4	-	-	G5	U9	AD8
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
-	-	CFG0	-	-	-	U10	AE3
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	37P	G0	G16	E16	G1	AB7	AD9
1	37N	H30	G17	E17	H31	AA8	AD10
1	38P	H28	G18	E18	H29	AB8	AE4
1	38N	H26	G19	E19	H27	AB9	AE5
1	39P	H24	G20	E20	H25	W9	AE6
1	39N	H22	G21	E21	H23	Y9	AE7
1	40P	H20	G22	E22	H21	AB10	AE8
1	40N	H18	G23	E23	H19	AA10	AE9
1	-	H16/VREF1	-	-	H17	W10	AE10
1	41P	H14	G24	E24	H15	Y10	AF3
1	41N	H12	G25	E25	H13	Y11	AF4
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
1	42P	H10	G26	E26	H11	V9	AF5
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	42N	H8	G27	E27	H9	V10	AF6
1	43P	H6	G28	E28	H7	AA11	AF7
-	-	GND	-	-	-	GND	GND
1	43N	H4	G29	E29	H5	AB11	AF8
-	-	VCC	-	-	-	VCC	VCC
1	44P	H2	G30	E30	H3	U11	AF9
1	44N	H0	G31	E31	H1	V11	AF10
2	45P	I0	J0	L0	I1	AB12	AF17
-	-	VCC	-	-	-	VCC	VCC
2	45N	I2	J1	L1	I3	AA12	AF18

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
2	63P	K8	L20	-	K9	AA19	AA18
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	63N	K10	L21	-	K11	U17	Y18
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	64P	K12	L22	-	K13	V18	AD25
2	64N	K14	L23	-	K15	AB21	AD26
2	65P	K16	L24	-	K17	U18	AC23
2	65N	K18	L25	-	K19	T17	AC24
2	66P	K20	L26	-	K21	AB20	AC25
2	66N	K22	L27	-	K23	AA20	AC26
2	67P	K24	L28	-	K25	Y19	AB22
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	67N	K26	L29	-	K27	V19	AB23
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	68P	K28	J16	L16	K29	T18	AB24
2	68N	K30	J17	L17	K31	R17	AB25
2	69P	L0	J18	L18	L1	U19	AB26
2	69N	L2	J19	L19	L3	T19	AA26
2	70P	L4	L30	I24	L5	V20	AA22
-	-	VCC	-	-	-	VCC	VCC
2	70N	L6	L31	I26	L7	U20	Y21
2	71P	L8	J20	L20	L9	W20	AA23
2	71N	L10	J21	L21	L11	Y21	AA24
2	72P	L12	J22	L22	L13	R18	AA25
2	72N	L14	J23	L23	L15	R19	Y26
-	-	GND	-	-	-	GND	GND
2	73P	L16	J24	L24	L17	W21	Y22
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	73N	L18	J25	L25	L19	Y22	Y23
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	74P	L20	J26	L26	L21	R20	W20
2	74N	L22	J27	L27	L23	P20	V20
2	75P	L24	J28	L28	L25	T21	W21
2	75N	L26	J29	L29	L27	R21	V21
2	76P	L28	J30	L30	L29	U21	Y24
2	76N	L30	J31	L31	L31	V21	Y25
2	77P	N0	P0	N0	N1	—	W22
2	77N	N2	P1	N1	N3	—	W23
2	78P	N4	P2	N2	N5	—	W24
-	-	VCC	-	-	-	VCC	VCC
2	78N	N6	P3	N3	N7	—	W25
-	-	GND	-	-	-	GND	GND
2	79P	N8	P4	N4	N9	—	W26

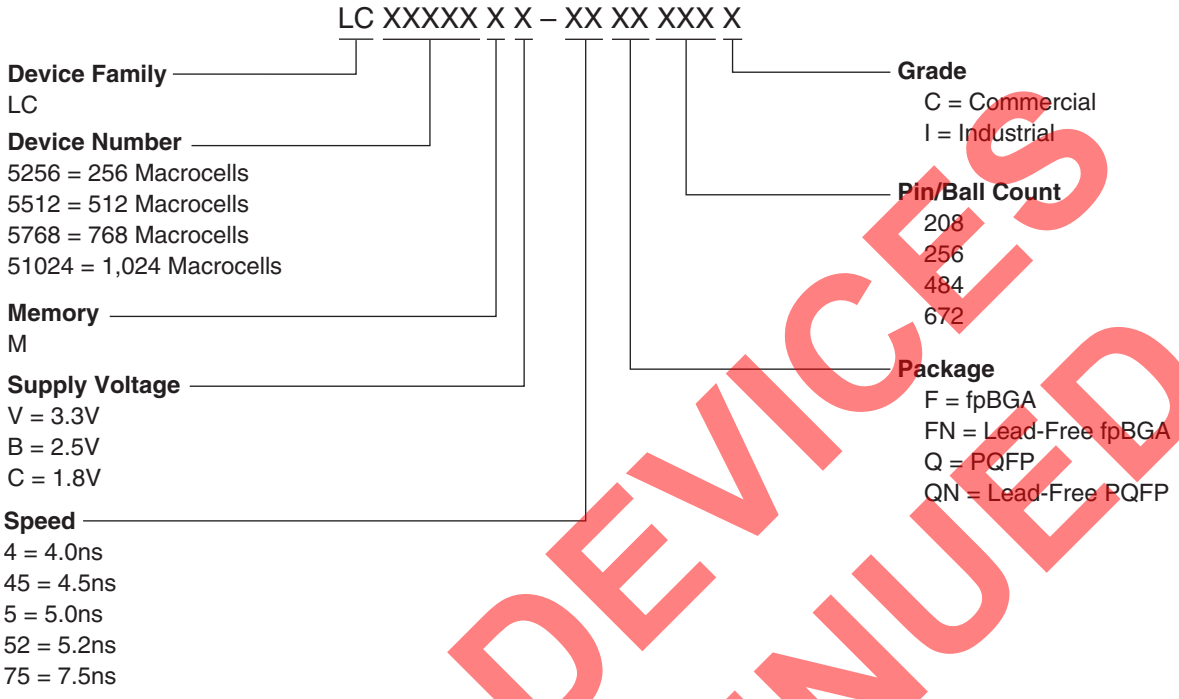
ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	GCLK3P	GCLK3	-	-	-	N16	N24
3	93N	R0	T31	R31	R1	J22	N23
3	93P	R2	T30	R30	R3	H22	N22
3	94N	R4	T29	R29	R5	N19	M26
3	94P	R6	T28	R28	R7	P15	M25
3	95N	R8	T27	R27	R9	P21	M23
3	95P	R10	T26	R26	R11	N15	M22
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	96N	R12	T25	R25	R13	M15	N20
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	96P	R14	T24	R24	R15	N20	M20
-	-	GND	-	-	-	GND	GND
3	97N	R16	T23	R23	R17	P22	N21
3	97P	R18	T22	R22	R19	N21	M21
3	98N	R20	T21	R21	R21	N17	M24
3	98P	R22	T20	R20	R23	M20	L24
3	99N	R24	T19	R19	R25	P17	L23
-	-	VCC	-	-	-	VCC	VCC
3	99P	R26	T18	R18	R27	P18	L22
3	100N	R28	T17	R17	R29	M21	L25
3	100P	R30	T16	R16	R31	M17	K26
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	101N	T0	T15	R15	T1	L20	K25
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	101P	T2	T14	R14	T3	N18	K24
3	102N	T4	T13	R13	T5	L21	K23
3	102P	T6	T12	R12	T7	M18	K22
3	103N	T8	T11	R11	T9	L22	J25
3	103P	T10	T10	R10	T11	L17	J24
3	104N	T12	T9	R9	T13	K22	L21
3	104P	T14	T8	R8	T15	L18	K21
3	105N	T16	T7	R7	T17	K21	L20
3	105P	T18	T6	R6	T19	K18	K20
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	106N	T20	T5	R5	T21	K20	J23
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	106P	T22	T4	R4	T23	K17	J22
3	107N	T24	T3	R3	T25	K19	J26
3	107P	T26	T2	R2	T27	J17	H26
3	108N	T28	T1	R1	T29	E22	H25
3	108P	T30/PLL_FBK1	T0	R0	T31	E21	H24
3	109N	U0/PLL_RST1	X27	V27	U1	G22	H23
3	109P	U2	X26	V26	U3	F21	H22

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
0	142N	Y26	Y29	AA29	Y27	B11	A10
0	142P	Y24	Y28	AA28	Y25	A11	A9
0	143N	Y22	Y27	AA27	Y23	F11	A8
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	143P	Y20	Y26	AA26	Y21	F10	A7
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	144N	Y18	Y25	AA25	Y19	E10	A6
0	144P	Y16	Y24	AA24	Y17	C10	A5
0	145N	Y14/VREF0	Y3	AA3	Y15	D10	A4
0	145P	Y12	Y2	AA2	Y13	B10	A3
0	146N	Y10	Y23	AA23	Y11	A10	B10
0	146P	Y8	Y22	AA22	Y9	A9	B9
0	147N	Y6	Y21	AA21	Y7	C9	B8
0	147P	Y4	Y20	AA20	Y5	D9	B7
0	148N	Y2	Y19	AA19	Y3	F9	B6
0	148P	Y0	Y18	AA18	Y1	E9	B5
0	149N	Z30	Y1	AA1	Z31	A8	B4
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	149P	Z28	Y0	AA0	Z29	B8	B3
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	150N	Z26	AA29	-	Z27	A7	C10
0	150P	Z24	AA28	-	Z25	B7	C9
0	151N	Z22	AA27	-	Z23	A5	C8
0	151P	Z20	AA26	-	Z21	B5	C7
0	152N	Z18	AA25	-	Z19	B6	C6
0	152P	Z16	AA24	-	Z17	C7	C5
0	153N	Z14	AA23	-	Z15	E8	C4
0	153P	Z12	AA22	-	Z13	E7	D5
0	154N	Z10	AA21	-	Z11	E6	D9
-	-	VCC	-	-	-	VCC	VCC
0	154P	Z8	AA20	-	Z9	D6	D8
-	-	GND	-	-	-	GND	GND
0	155N	Z6	AA19	-	Z7	D8	D7
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	155P	Z4	AA18	-	Z5	F8	D6
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	156N	Z2	AA17	-	Z3	F7	F9
0	156P	Z0	AA16	-	Z1	D7	E9
0	157N	AA30	AA15	-	AA31	C6	F7
0	157P	AA28	AA14	-	AA29	C5	F8
0	158N	AA26	AA13	-	AA27	C4	G8
0	158P	AA24	AA12	-	AA25	D5	G9

Part Number Description



Ordering Information

Note: For voltage families offered in industrial temperature grades and for all but the slowest commercial speed grade, the speed grades on these devices are dual marked. For example, the commercial speed grade -45XXXXC is also marked with the industrial grade -75I. The commercial grade is always one speed grade faster than the associated dual mark industrial grade. The slowest commercial speed grade is marked as commercial grade only. In addition, the fastest commercial speed grade (-5) for the LC5768MB/MV devices, at Lattice's discretion, will utilize either a commercial grade only single-mark or a dual-mark format in conjunction with the slower industrial speed grade (-75).

Conventional Packaging

ispXPLD 5000MC (1.8V) Commercial Devices

Device	Part Number	Macrocells	Voltage (V)	t_{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MC	LC5256MC-4F256C	256	1.8	4.0	fpBGA	256	141	C
	LC5256MC-5F256C	256	1.8	5.0	fpBGA	256	141	C
	LC5256MC-75F256C	256	1.8	7.5	fpBGA	256	141	C
LC5512MC	LC5512MC-45Q208C	512	1.8	4.5	PQFP	208	149	C
	LC5512MC-75Q208C	512	1.8	7.5	PQFP	208	149	C
	LC5512MC-45F256C	512	1.8	4.5	fpBGA	256	193	C
	LC5512MC-75F256C	512	1.8	7.5	fpBGA	256	193	C
	LC5512MC-45F484C	512	1.8	4.5	fpBGA	484	253	C
	LC5512MC-75F484C	512	1.8	7.5	fpBGA	484	253	C